

General Description:

The high breakdown voltage, fast switching speed and high forward conductance of this diode packaged in a DO-35 miniature Glass Axial leaded package makes it desirable also as a general purpose diode.

High Conductance Fast Diode

Features:

- 500 milliwatt Power Dissipation package.
- Fast Switching Speed,
- Typical capacitance less than 1.0 picofarad.

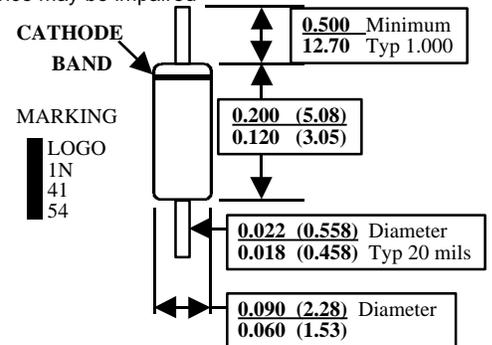
Ordering:

- 13 inch reel, 50 mm (T50R) & 26 mm (T26R) Tape; 10,000 units per reel.

Absolute Maximum Ratings* TA = 25°C unless otherwise noted

| Sym | Parameter | Value | Units |
|-----------------------|---|-------------|-------|
| T _{stg} | Storage Temperature | -65 to +200 | °C |
| T _J | Operating Junction Temperature | 175 | °C |
| P _D | Total Power Dissipation at T _A = 25°C | 500 | mW |
| | Linear Derating Factor from T _A = 25°C | 3.33 | mW/°C |
| R _{OJA} | Thermal Resistance Junction-to-Ambient | 300 | °C/W |
| W _{iv} | Working Inverse Voltage | 35 | V |
| I _O | Average Rectified Current | 100 | mA |
| I _F | DC Forward Current (I _F) | 300 | mA |
| i _f | Recurrent Peak Forward Current (I _F) | 400 | mA |
| i _{F(surge)} | Peak Forward Surge Current (I _{FSM}) Pulse Width = 1.0 second | 1.0 | Amp |
| | Pulse Width = 1.0 microsecond | 4.0 | Amp |

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired



Electrical Characteristics TA = 25°C unless otherwise noted

| SYM | CHARACTERISTICS | MIN | MAX | UNITS | TEST CONDITIONS |
|-----------------|-----------------------|-----|------------|----------|--|
| B _V | Breakdown Voltage | 35 | | V | I _R = 5.0 uA |
| I _R | Reverse Leakage | | 100 100 | nA uA | V _R = 25 V V _R = 25 V, T _A = 150°C |
| V _F | Forward Voltage | | 1.0 | V | I _F = 30 mA |
| C _T | Capacitance | | 4.0 | pF | V _R = 0.0 V, f = 1.0 MHz |
| T _{RR} | Reverse Recovery Time | | 4.0 | ns | I _F = 10 mA V _R = 6.0 V I _{RR} = 1.0 mA, R _L = 100 ohms |

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PRODUCT STATUS DEFINITIONS

Definition of Terms

| Datasheet Identification | Product Status | Definition |
|--------------------------|------------------------|---|
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